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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/834,696	04/12/2001	Jerrold L. King	MICR135.02		
75	590 09/12/2002				
Ormiston & McKinney, PLLC			EXAMINER		
P.O. Box 298 8 W. Bannock, St	uite 400		MITCHELL, JAMES M		
Boise, ID 8370	01-0298		ART UNIT	PAPER NUMBER	
			2827		
			DATE MAILED: 09/12/2002		

Please find below and/or attached an Office communication concerning this application or proceeding.

			.,	N/				
	Application No.		Applicant(s)					
	09/834,696		KING ET AL.					
Office Action Summary	Examiner		Art Unit					
	James Mitchell		2827					
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply								
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).								
Status	A							
1) Responsive to communication(s) filed on 22 /		a a l						
20,2 1,10 0010111011111	nis action is non-fir		osocution as to th	na marite ie				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims								
4)⊠ Claim(s) 19,23 and 24 is/are pending in the application.								
4a) Of the above claim(s) is/are withdrawn from consideration.								
5) Claim(s) is/are allowed.								
6)⊠ Claim(s) <u>19,23 and 24</u> is/are rejected.								
7) Claim(s) is/are objected to.								
8) Claim(s) are subject to restriction and/or election requirement.								
Application Papers								
9)☐ The specification is objected to by the Examiner.								
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.								
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
11)☐ The proposed drawing correction filed on is: a)☐ approved b)☐ disapproved by the Examiner.								
If approved, corrected drawings are required in reply to this Office action.								
12)☐ The oath or declaration is objected to by the Examiner.								
Priority under 35 U.S.C. §§ 119 and 120								
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).								
a) All b) Some * c) None of:								
1. Certified copies of the priority documents have been received.								
2. Certified copies of the priority documents have been received in Application No								
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 								
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).								
a) ☐ The translation of the foreign language provisional application has been received. 15)☑ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.								
Attachment(s)								
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	4)	Notice of Informal	y (PTO-413) Paper N Patent Application (P					

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DETAILED ACTION

Claim Rejections - 35 USC § 112

1. The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

- 2. Claims 19 is rejected under 35 U.S.C. 112, first paragraph, as containing subject matter which was not described in the specification in such a way as to enable one skilled in the art to which it pertains, or with which it is most nearly connected, to make and/or use the invention. It is not enabled how applicant makes "fully encapsulating the conductive leads" when applicant explicitly states on Page 3, Lines 28-29 that the encapsulant has openings to provide contact to leads.
- 3. Further the claim contain subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. There is no support for "fully encapsulating the leads" when applicant explicitly states that the encapsulant has openings to provide contact to leads.
- 4. The following is a quotation of the second paragraph of 35 U.S.C. 112:

 The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 5. Claims 19 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. The step of "fully encapsulating lead" is mutually exclusive

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from having lead encapsulated with openings in the encapsulant for contact with the lead.

Claim Rejections - 35 USC § 102

6. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.
- 7. The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) do not apply to the examination of this application as the application being examined was not (1) filed on or after November 29, 2000, or (2) voluntarily published under 35 U.S.C. 122(b). Therefore, this application is examined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).
- 8. Claim 19 is rejected under 35 U.S.C. 102(b) as being anticipated by Ichiyama et al. (U.S 5,373,190).
- 9. Ichiyama (Fig 1) discloses a semiconductor chip package comprising a chip (1) conductive leads (8) electrically connected to and extending over a surface of the chip, a continuous body of inherent insulative encapsulating material (4) covering at least a portion of the chip and fully encapsulating the conductive leads (8; understood to mean the lead fully encapsulated except for immediate point of contact with an electrode/solderball) and electrodes (13) each having a first portion disposed in the encapsulating material and contacting a conductive lead and a second portion

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protruding from the encapsulating material, said chip having in the alternative bond pads (8) with conductive leads (10) attached to the insulating material, wherein each lead is electrically connected to and extending over the bond pad.

Claim Rejections - 35 USC § 103

- 10. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 11. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 12. Claims 23 and 24 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ichiyama in combination with Tsukada.
- 13. Ichiyama discloses the elements stated in paragraph 9, but does not appear to explicitly disclose that the terminals are solder balls having a first portion disposed in the encapsulating material and contacting a conductive lead, and a second portion protruding from the encapsulating material.

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14. However, Tsukada utilizes terminals that are solder balls.

15. It would have been obvious to one of ordinary skill in the art to form the terminals of Ichiyama as solder balls in order to provide terminals as taught by Tsukada (English Abstract).

Response to Arguments

Applicant's arguments filed August 22, 2202 have been fully considered but they 16. are not persuasive. In regards to the 112 rejection of claim 19, applicant contends that there is nothing indefinite or unclear about the structure and cites to the specification to reinforce its position. However the reference to the specification only recites a portion of the process step (as illustrated in the remaining steps of forming openings in the encapsulating material) that carries no patentable weight in relation to the final device structure. The structure as correctly articulated by the applicant (Page 3 of the response) has, "fully encapsulating .. conductive leads except for the immediate point of contact with an electrode ..." While examiner sympathizes with the applicant's position that it may not be "desirable to expressly recite" the limitation. While the applicant can claim as much or as little of the invention, applicant cannot claim what is not the invention. Respectively, persons skilled in the art, along with judges and jurors would readily see and understand that "a device claim" cannot be structurally limited by its process of making unless it imparts a structural limitation. In the instant case, a lead being "fully encapsulated" is not a structural limitation imparted by applicant's process as shown in applicant's specification.

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17. Applicant's arguments with respect to the prior art rejection of claims 19, 23 and 24 have been considered but are moot in view of the new ground(s) of rejection prompted by applicants indication of an earlier filing date.

Conclusion

18. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Sawai (U.S 5,554,887).

The prior art discloses in Sawai the use of a ball in an encapsulated chip package with a portion of the ball in the encapsulating material and a portion protruding from the encapsulating material.

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to James Mitchell whose telephone number is (703) 305-0244. The examiner can normally be reached on M-F 10:30-8:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David L. Talbott can be reached on (703) 305-9883. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 305-3432 for regular communications and (703) 305-3230 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

jmm September 6, 2002 DAVID L. TALBOTT SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800

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